Dual-Band Ring Coupler Based on the Composite Right/Left-Handed Folded Substrate-Integrated Waveguide

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Abstract-In this letter, a dual-band ring coupler based on the folded substrate-integrated waveguide (FSIW) is proposed. The artificial structure, the composite right/left-handed (CRLH) transmission lines were implemented in the FSIW by loading the interdigital capacitors in the middle metallic layer to generate a left-handed passband region below the cutoff frequency of the ordinary waveguide TE₁₀ mode for coupler miniaturization. The FSIW is the folded counterpart of the substrate-integrated waveguide (SIW) and thus can prevent the CRLH transmission lines from radiation loss by shielding the interdigital capacitors in the waveguide. Besides, the FSIW-based coupler is able to eliminate the electromagnetic interference (noise) with adjacent objects and lend itself to multilayer circuit integration. A ring coupler that operates at 4.3 and 7.6 GHz was developed and experimentally verified. To the best of the authors' knowledge, it is the first time that a dual-band rat-race was implemented and reported based on the CRLH-FSIW structure.

Index Terms—Composite right/left-handed (CRLH), dual-band, folded substrate-integrated waveguide (FSIW), ring coupler.

I. INTRODUCTION

R ING hybrids that are capable of dual-band or multi-band operation and lend themselves easily to system integration are of great importance for many microwave circuits, such as push-pull amplifiers and balanced mixers, in ever demanding communication systems. Dual-band ring hybrids have been extensively reported in the literature [1]–[6]. The microstrip lines in a variety of prototypes, such as the T model [1], π model [2], and the artificial lines [3], [4], render a facile solution to size-reduced and dual-band couplers, but performance degradation due to the nature of open structures makes microstrip lines less preferable especially for stringent system specifications. The study on the substrate-integrated waveguides (SIWs) [7], [8] to replace the bulky metallic waveguides proposes a useful approach to low loss and inexpensive implementation. The ridge SIW based ring hybrid [5] demonstrates dual-band characteristics by using two concentric ring couplers for the respective

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bands. The implementation of ridges as well as the radial transverse slots over the un-ridged wall of the outer coupler needs precise drilling and machining, leading to considerable fabrication cost. The dual-band coupler [6] by dispersion engineering of the composite right/left-handed (CRLH) transmission lines was developed with the half-mode SIW where the interdigital capacitors on top metal surface become the unwanted radiation source and degrade the overall performance.

Recent investigation on the folded substrate-integrated waveguide (FSIW) [9] shows that the FSIW can reduce the width by about one half while exhibiting nearly identical dispersion characteristics when compared to the SIW, indicating the possibility for size reduction. Moreover, when applying the CRLH transmission line theory, the interdigital capacitors can be designed in the middle metallic layer enclosed completely by the top and bottom ground planes, maintaining the radiation-free property of a closed structure [10]. The FSIW structures have been used for applications of filters and coupled-line couplers [10]–[12], but less effort was made on the dual-band ring couplers. Therefore, in this work, the FSIW technology was applied for realization of a dual-band coupler where the model of the CRLH transmission line was developed by inserting the interdigital capacitors to generate a left-handed passband mode below the cutoff frequency of the waveguide TE_{10} mode, allowing for passband operation at lower frequencies [10]. The proposed coupler is compatible with planar PCB circuitry or can be easily integrated into multilayer circuitry. Details on structural parameters and design procedure will be given in next sections. Good agreement is achieved between measured and full-wave simulated results.

II. COUPLER DEVELOPMENT AND DESIGN PROCEDURE

The proposed dual-band CRLH rat-race coupler was developed in the FSIW, consisting of two stacked layers of the Rogers 5880 substrates of thickness $h=1.57~\mathrm{mm}$ and of dielectric constant $\varepsilon_{\mathrm{r}}=2.2$. In order to mitigate the effects from the dielectric loss and dielectric constant of the bonding film, the Rogers 3001 bonding film ($\varepsilon_{\mathrm{r}}=2.28,\,h=0.038~\mathrm{mm}$) was used, which was shown effective for loss reduction [10]. This coupler has three metallic layers with ground planes on the top and bottom layers, and the interdigital capacitors were introduced in the middle layer to develop the model of the CRLH transmission lines as shown in Fig. 1. The correspondence between the physical structure and the lumped elements of the CRLH lines will be detailed in Section II-A. The proposed coupler is fed by the conductor-backed coplanar waveguide (CB-CPW) in order to comply with the TE_{10} mode distribution in the FSIW where

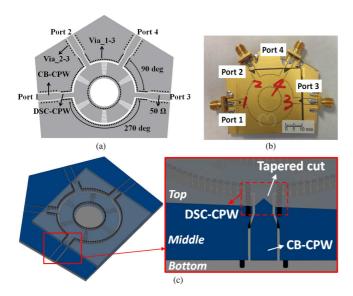


Fig. 1. (a) Configuration of the middle metallic (signal) layer, (b) the photograph and (c) the perspective view of the proposed dual-band ring hybrid based on the FSIW structure. The close-up of the feeding structure and the tapered transition section is shown for clarity.

the electric field is most concentrated around the gap along the outer perimeter of the ring and is oriented in the horizontal direction. Note that the upper substrate is smaller than the lower substrate simply for convenience of the feed line design. In addition to the via arrays (denoted as via_1-3) used as the side walls, the vias on both sides (denoted as via_2-3) of the signal strip of the CB-CPW are used to connect the lateral ground planes (middle layer) to the bottom ground plane, avoiding the excitation of the parallel-plate mode.

A. The 90° Sections

As shown in Fig. 1(a), the dual-band ring hybrid is composed of six identical CRLH unit cells, each of which was designed to exhibit a 90° phase advance and a 90° phase delay at the first f_1 and the second f_2 bands, respectively. The details of the proposed unit cell are given in Fig. 2. The two arrays of vias along the perimeter of the ring arm form side walls of the FSIW and connect the middle metallization to the top and bottom ground planes (via 1-3). The vias are 0.55 mm in diameter, and via distances are 0.78 mm and 0.8 mm for inner and outer arrays, respectively. Referring to Fig. 2(b) for the CRLH circuit model, the interdigital capacitors in the unit cell contribute to the series capacitance $C_{\rm L}$ while the shunt inductance L_{L} is determined by the inner vias and the width W of the conductor strip. In addition, the series inductance $L_{\rm R}$ and shunt capacitance $C_{\rm R}$ are resulted from the distributed inductance and capacitance of the waveguide, respectively. The unit cell is optimized in a fashion that the desired phase and impedance responses are fulfilled in both bands. The physical dimensions are as follows: $W = 6.15 \text{ mm}, R = 7.7 \text{ mm}, g = 0.75 \text{ mm}, \theta_i = 10^{\circ},$ gap and width of the interdigital capacitors are both 0.17 mm. Based on these parameters, Fig. 3 shows the full-wave characterization of the dispersion relation and impedance. The unit cell shows the 90° phase-leading at 4.3 GHz in the left-handed region while having the 90° phase-lagging at 7.6 GHz in the right-handed region. Furthermore, the impedances of 70.7 Ω are

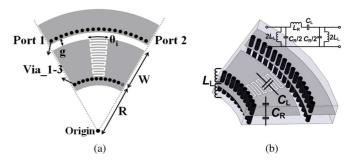


Fig. 2. (a) Top view of the middle layer and (b) the lumped-element correspondence of the proposed unit cell with the CRLH equivalent circuit parameters.

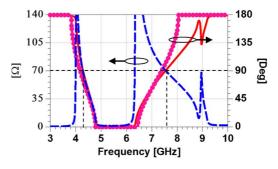


Fig. 3. Full-wave (HFSS) calculated phase (solid) and impedance (dashed) responses of the proposed CRLH unit cell. The dispersion relation (with circle symbol) calculated from the circuit model is illustrated and the lumped parameters are $C_{\rm L}=0.108~{\rm pF},\,L_{\rm L}=0.932~{\rm nH},\,L_{\rm R}=10.275~{\rm nH},\,C_{\rm R}=0.653~{\rm pF}.$

obtained in both bands. The extracted lumped parameters of the proposed unit cell are given in Fig. 3 where the corresponding dispersion curve of the circuit model is compared. Note that the CRLH circuit model shown in Fig. 2(b) is a simplified model and it is valid only in a limited frequency range. In addition, in Fig. 3 the high-pass cutoff frequency of the left-handed region occurs at about 4 GHz, which is considerably lower than the cutoff of the original (unloaded) FSIW at about 6.6 GHz and thus offers the advantage for size reduction. Moreover, due to the close proximity to the cutoff, the variations of the dispersion and impedance curves versus frequency are large at f_1 , resulting in the narrow bandwidth in the first band. The left-handed passband can be reduced further by increasing interdigital capacitance and thus results in an enhancement of dual-band frequency ratio, but the self-resonance of the capacitors will occur and degrade the performance in the second band. For demonstration purpose only, the frequency ratio of 1.8 is implemented in this work.

B. The Tapered Transition Sections

In order to feed the FSIW coupler by the CB-CPW, a transition section, which is termed as the double-sided conductor CPW (DSC-CPW), was designed and illustrated in Fig. 1(c). Note that the DSC-CPW is a three-metal-layer architecture where the CPW-like geometry is designed in the middle plane to connect the input CB-CPW while the top/bottom surfaces are ground planes and consistent with those of the FSIW. Thus the DSC-CPW can mainly maintain field distribution of the CB-CPW for proper excitation. Furthermore, in addition to the tapered signal line, a tapered cut in the top metallization

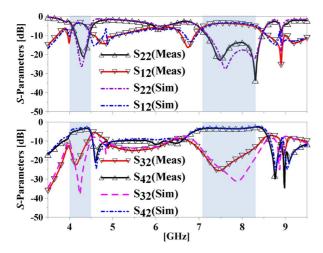


Fig. 4. Measured and simulated S-parameters obtained at port 2 (Σ port)

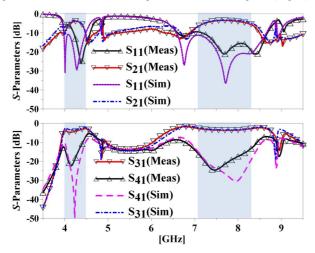


Fig. 5. Measured and simulated S-parameters obtained at port 1 (Δ port).

TABLE I COMPARISON OF COUPLER PERFORMANCES

	Reduced	Loss	Ease of	Frequency
	Size*	2033	Fabrication	Ratio
This Work	Yes	Low	Medium	1.8
[1]	No	High	Easy	2.4
[2], [3]	Yes	High	Easy	2.1, 2
[5]	No	Low	Hard	2.8
[6]	No	High	Easy	1.6

^{*} Size reduction is determined by comparing the ring footprint of the dual-band coupler to the single-band, microstrip hybrid operating in the lower band of the dual frequencies when the same substrate is employed.

was used to reduce the reflection at waveguide discontinuity as shown in Fig. 1(c).

III. SIMULATED AND MEASURED RESULTS

The proposed ring coupler was experimentally developed on two stacked laminates (Rogers 5880) with three metal layers to implement the FSIW. Fig. 1(b) shows the photograph of the fabricated coupler with the ports numbering convention as indicated. The measured S-parameters are given in Figs. 4 and 5 and compared to the HFSS-simulated results. Very good agreement was obtained. Due to the limited space, only the magnitude

responses are given here. The dual-band characteristics are verified both by measurement and simulation. The measured insertion losses are 3.7 dB and 3.5 dB at Σ port, and 3.9 dB and 3.5 dB at Δ port at 4.3 and 7.6 GHz, respectively. Measured insertion losses are slightly higher than those from simulation and can be ascribed to the fabrication error. In addition, the measured bandwidths for > 15 dB return loss are 4.6% and 13.9% at Σ port, and 5.7% and 14.1% at Δ port. The bandwidths for >15 dB isolation are 7.0% and 15.5% at 4.3 and 7.6 GHz, respectively. The measured bandwidths obtained at Σ/Δ ports for 1 dB magnitude imbalance are 3.7%/5.7% and 11.2%/10.1% at 4.3 and 7.6 GHz, respectively. Similarly, the bandwidths obtained at Σ/Δ ports for 10° phase imbalance are 6.8%/6.7% and 13.6%/13.1%. As expected and discussed in Section II-A, smaller fractional bandwidths at the lower passband are observed. In Table I, the comparison of the coupler performances is given.

IV. CONCLUSION

A dual-band ring coupler was developed and fabricated based on the CRLH-FSIW structure. The proposed prototype is well suited for applications of low loss and multilayer circuitry integration.

REFERENCES

- [1] K.-S. Chin, K.-M. Lin, Y.-H. Wei, T.-H. Tseng, and Y.-J. Yang, "Compact dual-band branch-line and rat-race couplers with stepped-impedance-stub lines," *IEEE Trans. Microw. Theory Tech.*, vol. 58, no. 5, pp. 1213–1221, May 2010.
- [2] C.-L. Hsu, J.-T. Kuo, and C.-W. Chang, "Miniaturized dual-band hybrid couplers with arbitrary power division ratios," *IEEE Trans. Microw. Theory Tech.*, vol. 57, no. 1, pp. 149–156, Jan. 2009.
- [3] P.-L. Chi and T. Itoh, "Miniaturized dual-band directional couplers using composite right/left-handed transmission structures and their applications in beam pattern diversity systems," *IEEE Trans. Microw. Theory Tech.*, vol. 57, no. 5, pp. 1207–1215, May 2009.
- [4] G. Siso, J. Bonache, and F. Martin, "Dual-band rat race hybrid coupler implemented through artificial lines based on complementary split ring resonators," in *IEEE MTT-S Int. Dig.*, Boston, MA, 2009, pp. 625–628.
- [5] T. Djerafi, H. Aubert, and K. Wu, "Ridge substrate integrated waveguide (RSIW) dual-band hybrid ring coupler," *IEEE Microw. Wireless Compon. Lett.*, vol. 22, no. 2, pp. 70–72, Feb. 2012.
- [6] Y. Dong and T. Itoh, "Application of composite right/left-handed half-mode substrate integrated waveguide to the design of a dual-band rat-race coupler," in *IEEE MTT-S Int. Dig.*, Anaheim, CA, 2010, pp. 712–715.
- [7] D. Deslandes and K. Wu, "Integrated microstrip and rectangular waveguide in planar form," *IEEE Microw. Wireless Compon. Lett.*, vol. 11, no. 2, pp. 68–70, Feb. 2001.
- [8] Y. Cassivi, L. Perregrini, P. Arcioni, M. Bressan, K. Wu, and G. Conciauro, "Dispersion characteristics of substrate integrated rectangular waveguide," *IEEE Microw. Wireless Compon. Lett.*, vol. 12, no. 9, pp. 333–335, Sep. 2002.
- [9] W. Che, L. Geng, K. Deng, and Y. Chow, "Analysis and experiments of compact folded subsrate-integrated waveguide," *IEEE Trans. Microw. Theory Tech.*, vol. 56, no. 1, pp. 88–93, Jan. 2008.
- [10] T. Yang, P.-L. Chi, R. Xu, and W. Lin, "Folded substrate integrated waveguide based composite right/left-handed transmission line and its application to partial H-plane filters," *IEEE Trans. Microw. Theory Tech.*, vol. 61, no. 2, pp. 789–799, Feb. 2013.
- [11] N. Grigoropoulos, B. Sanz-Izquierdo, and P. R. Young, "Substrate integrated folded waveguides (SIFW) and filters," *IEEE Microw. Wireless Compon. Lett.*, vol. 15, no. 12, pp. 829–831, Dec. 2005.
- [12] G. Zhai, W. Hong, K. Wu, J. Chen, P. Chen, J. Wei, and H. Tang, "Folded half mode substrate integrated waveguide 3 dB coupler," *IEEE Microw. Wireless Compon. Lett.*, vol. 18, no. 8, pp. 512–514, Aug. 2008